EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

0.8mm Height Flat Top LEDs

17-215UYC/S530-XX/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

Descriptions

- The 17-215 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.



- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol,
- General use.

Device Selection Guide

_		Chip	
	Material	Emitted Color	Lens Color
	AlGaInP	Super Yellow	Water Clear

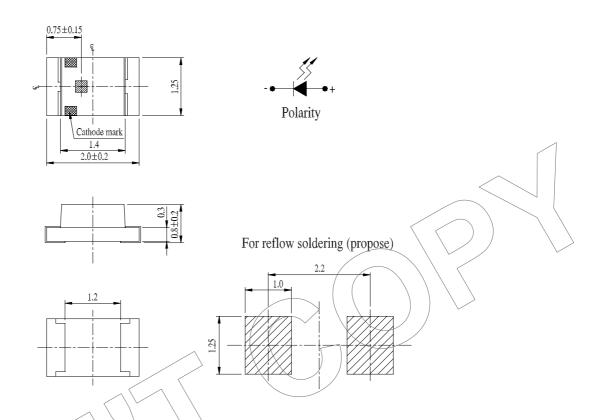


Device No.: DSE-175-052 ECN:



17-215UYC/S530-XX/TR8

Package Outline Dimensions



Notes: Tolerances Unless Dimension ± 0.1mm, Angle± 0.5°, Unit = mm

Absolute Maximum Ratings (Ta=25°C)

	<u> </u>		
Parameter	Symbol	Rating	Unit
Reverse Voltage	V_{R}	5	V
Forward Current	${ m I}_{ m F}$	25	mA
Operating Temperature	Topr	- 40 ∼ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	Tsol	260 (for 5 second)	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	IF	120	mA

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Device No.: DSE-175-052 ECN:

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Rev. 1.0

Page: 2 of 7



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17-215UYC/S530-XX/TR8

Electro-Optical Characteristics (Ta=25°C)

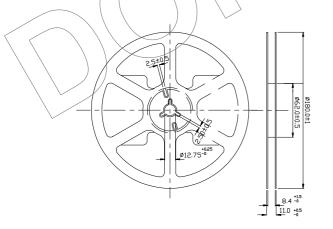
Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
	Iv	A2	17	43		mcd	I _F =20mA
		A3	41	64			
Luminous Intensity		A4	58	87			
		A5	69	110			
		A6	87	127			
Viewing Angle	2 \theta 1/2			130		deg	I _F =20mA
Peak Wavelength	λр			591		nm	IF=20mA
Dominant Wavelength	λd			589		nm	IF=20mA
Spectrum Radiation Bandwidth	Δλ			15		nm	I _F =20mA
Forward Voltage	VF		1.7	2.0	2.4	/ v	I _F =20mA
Reverse Current	Ir		>		10	μ A	V _R =5V

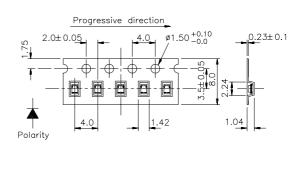
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Chip Rank

Reel & Carrier Tape Dimensions

Loaded quantity per reel 3000 PCS/reel





Notes: Tolerances Unless Dimension ± 0.1mm, Angle± 0.5°, Unit = mm

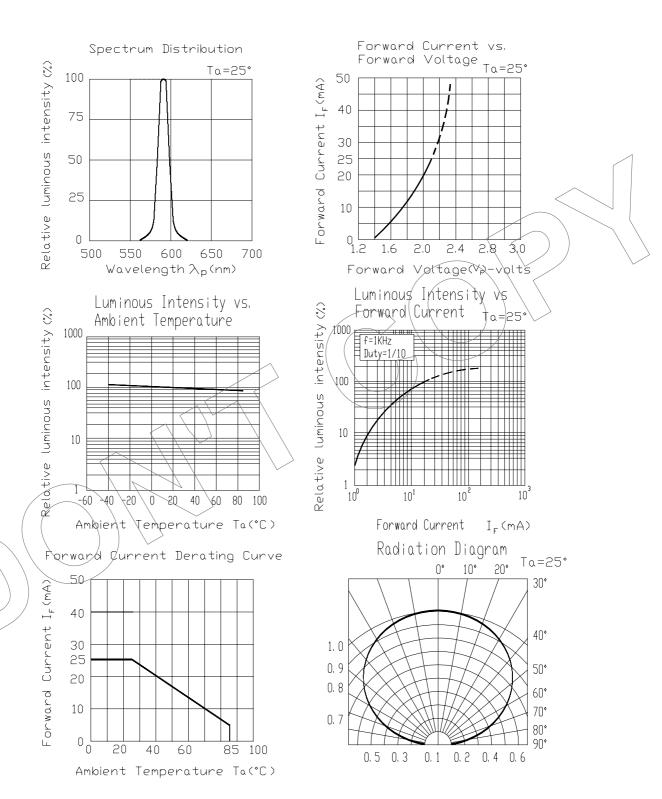
Device No.: DSE-175-052 ECN:



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17-215UYC/S530-XX/TR8

Typical Electro-Optical Characteristics Curves



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Reliability Test Items And Conditions

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Solder Heat	Temp. : 260°C± 5°C	5 Sec.	76 PCS.	0/1
2	Temperature Cycle	H:+85°C 30min ∫ 5 min L:-55°C 30min	50 Cycles	76 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	50 Cycles	76 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	76 PCS.	0/1
5	Low Temperature Storage	Temp.: -55°C	1000 Hrs.	76 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	76 PCS.	0/1
7	High Temperature High Humidity	85°C/RH85%	1000 Hrs.	76 PCS.	0/1

Device No.: DSE-175-052 ECN:



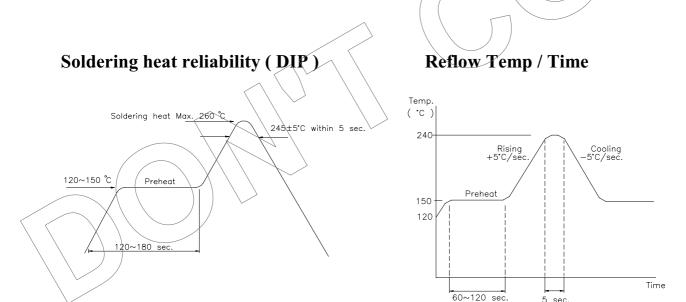
17-215UYC/S530-XX/TR8

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage time
 - 2.1 The operation of Temperature and RH are : 5° C \sim 35 $^{\circ}$ C, RH60%.
 - 2.2 Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year(from production date).
 - 2.3 If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, RH 60%, they should be treated at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 15hrs.
 - 2.4 When you discover that the desiccant in the package has a pink color (Normal = blue), you should treat them in the same conditions as 2.3.



Soldering Iron

Basic spec is ≤ 5 sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec). Power dissipation of Iron should be smaller than 15 W, and temperature should be controllable. Surface temperature of the device should be under 230 °C.

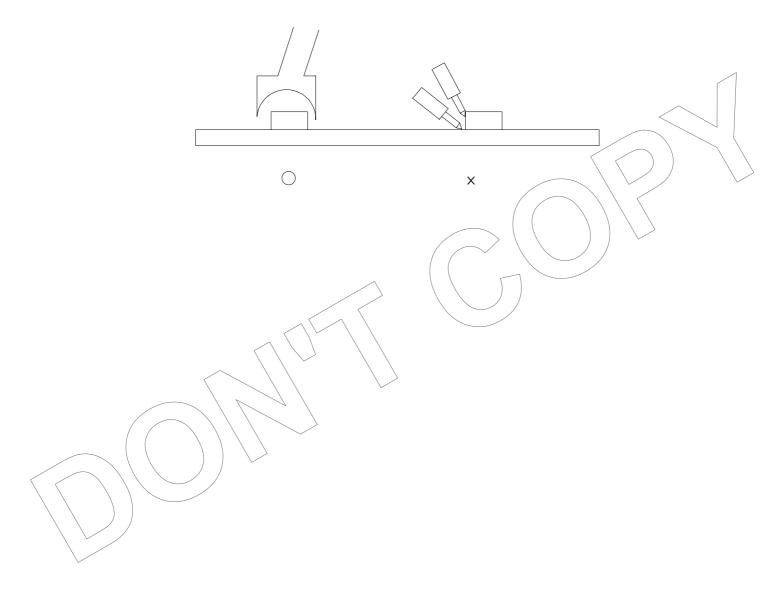
Device No.: DSE-175-052 ECN:



17-215UYC/S530-XX/TR8

Rework

- 1. Customer must finish rework within 5 sec under 245°C.
- 2. The head of iron can not touch copper foil.
- 3. Twin-head type is preferred.



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Page: 7 of 7